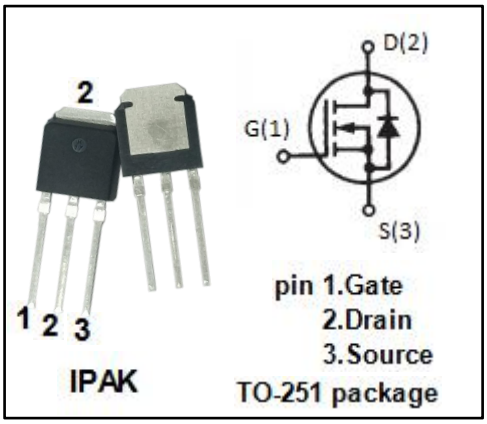
isc N-Channel MOSFET Transistor 2SK4080

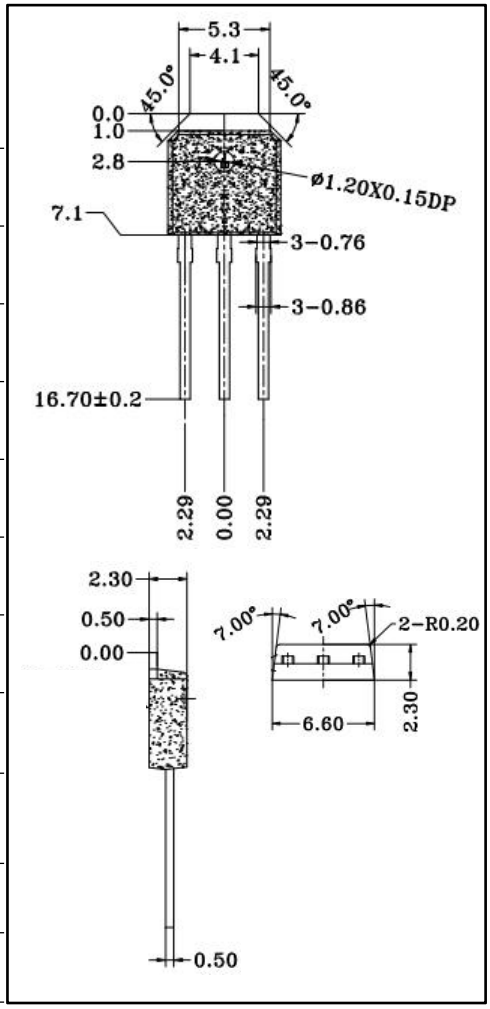
FEATURES

- Drain Current : I_D= 53A@ T_C=25℃
- Drain Source Voltage
  : V_{DSS}= 30V(Min)
- Static Drain-Source On-Resistance
  : $R_{DS(on)}$ = 90mΩ(Max) @ V_{GS}= 10V
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation



DESCRIPTION

- motor drive, DC-DC converter, power switch and solenoid drive.



ABSOLUTE MAXIMUM RATINGS(T_a=25℃)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage-Continuous	±20	V
I_D	Drain Current-Continuous	53	A
I_{DM}	Drain Current-Single Pluse	165	A
P_D	Total Dissipation @T_C=25℃	28	W
T_J	Max. Operating Junction Temperature	-55~150	℃
T_{stg}	Storage Temperature	-55~150	℃

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j\text{-}c}$	Thermal Resistance, Junction to Case	4.5	℃/W

isc N-Channel MOSFET Transistor 2SK4080

ELECTRICAL CHARACTERISTICS

T_C=25℃ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}= 0; I_D= 0.25mA	30	--	V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= 10V; I_D= 0.25mA	1.2	3.0	V
$R_{DS(on)1}$	Drain-Source On-Resistance	V_{GS}= 10V; I_D= 10A V_{GS}= 4.5V; I_D= 7A	--	90 110	mΩ
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±20V;V_{DS}= 0	--	±0.1	uA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 30V; V_{GS}= 0	--	1.0	uA
V_{SD}	Forward On-Voltage	I_S= 3.0A; V_{GS}= 0	--	1.2	V